

Low VF Glass Passivated Bridge Rectifiers 玻璃钝化低功耗整流桥

Reverse Voltage - 800 Volts 反向电压 800V Forward Current - 15 Amperes 正向电流 15A

Features 特征

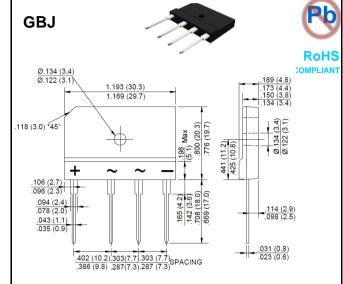
- Glass passivated chip 玻璃钝化芯片
- Low forward voltage drop 正向压降低
- Ideal for printed circuit board 适用于印刷电路板中
- High surge current capability 高的浪涌能力

Mechanical Data 外观信息

- Polarity: Symbol marked on body 极性:标志在产品的本体上
- Mounting position: Any 安装位置: 任何位置

Applications 应用

- General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.
- 一般应用于交流/直流桥式全波整流,如:开关电源,照明镇流器、适配器等。



Package Outline Dimensions in Inches (Millimeters)

封装外观尺寸单位英寸(毫米)

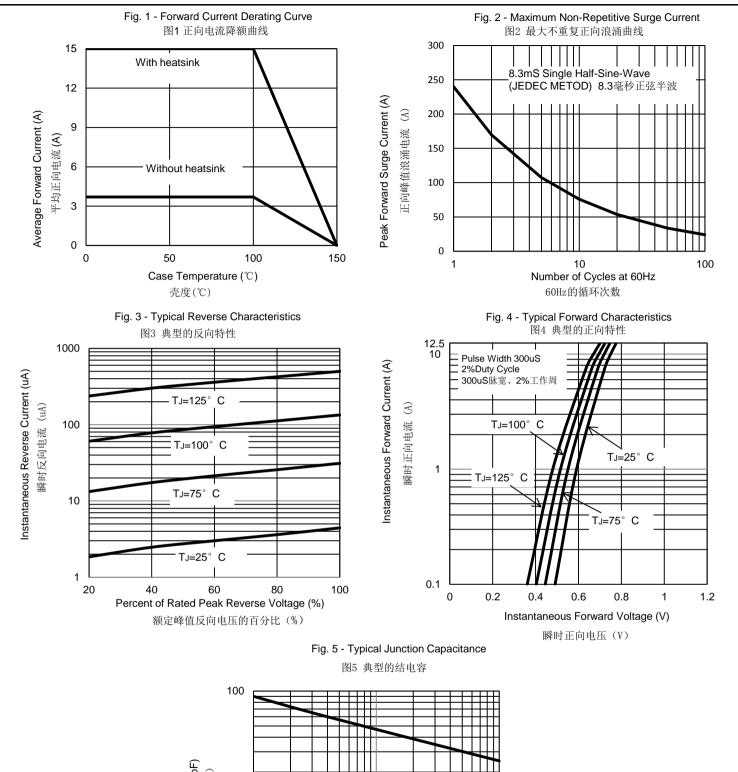
Maximum Ratings and Electrical Characteristics 最大额定值及电气特性

Rating at 25℃ ambient temperature unless otherwise specified. 环境温度25℃,除非特别说明。 Single phase, half wave, 60Hz, resistive or inductive load. 单相半波, 60Hz, 阻性或感性负载。 For capacitive load, derate current by 20%. 对于电容性负载,降低20%的额定电流。

Characteristics 特性	Symbol 符号	GBJ1508F	Unit 单位
Maximum Repetitive Peak Reverse Voltage 最大重复峰值反向电压	VRRM	800	V
Maximum RMS Voltage 最大有效反向电压	VRMS	560	V
Maximum DC Blocking Voltage 最大直流阻断电压	VDC	800	V
Maximum Average Forward Rectified Current (with heatsink Note 2)	I(AV)	15.0	^
最大正向平均整流电流 @ Tc=100℃ (without heatsink)		3.7	A
Peak Forward Surge Current, 8.3mS Single Half Sine-Wave,			
Superimposed on Rated Load (JEDEC Method)	IFSM	240	А
8.3mS单一正弦半波叠加在额定负载上的浪涌能力(JEDEC方法)			
I ² t Rating for Fusing (t<8.3mS) 熔断额定值 (t<8.3mS)	l ² t	239	A ² s
Peak Forward Voltage per Diode at 7.5A DC	VF	0.92	V
单个二极管在7.5A电流下的正向峰值电压	VF		
Maximum DC Reverse Current at Rated @TJ=25℃		5.0	
DC Bolcking Voltage per Diode @TJ=125°C	lR	500	μA
单个二极管在额定直流电压下的最大反向直流电流			
Typical Junction Capacitance per Diode (Note1) 典型结电容(备注1)	Сл	60	pF
Typical Thermal Resistance to Ambient (Note2)	Rеја	4.5	
结到环境的典型热阻值(备注2)			°C/W
Typical Thermal Resistance to case (Note2) 结到壳的典型热阻值(备注2)	Rejc	0.8	C/VV
Typical Thermal Resistance to lead (Note2) 结到引线的典型热阻值(备注2)	Rejl	1.5	
Operating Junction Temperature Range 结温工作范围	TJ	-55 to +150	$^{\circ}$
Storage Temperature Range 储存温度范围	Тѕтс	-55 to +150	°C

- Notes: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC. 在 1.0MHz 下和反向电压为 4.0V DC下测试。
 - 2.Device mounted on 300mm*300mm*1.6mm Cu plate heatsink. 安装在 300mm*300mm*1.6mm Cu 的散热片上。
 - 3.The typical data above is for reference only 典型值仅供参考.





Capacitance (pF) 10 TJ=25° C,f=1MHz

10

Reverse Voltage (V)

100

反向电压(V) The curve above is for reference only. 曲线图仅供参考。

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